



2A, 1000V Fast Recovery Bridge Rectifier

FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- High surge current capability
- UL Recognized file # E-326854
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

MECHANICAL DATA

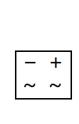
- · Case: ABS
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1 whisker test
- Polarity: As marked
- Weight: 0.096g (approximately)

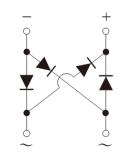
KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
lf	2	Α	
V_{RRM}	1000	V	
I _{FSM}	50	Α	
T _{J MAX}	150	°C	
Package	ABS		
Configuration	Quad		





ABS





ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)				
PARAMETER		SYMBOL	RABS20M	UNIT
Marking code on the device			RA20M	
Repetitive peak reverse voltage		V _{RRM}	1000	V
Reverse voltage, total rms value		V _{R(RMS)}	700	V
Forward current		IF	2	А
Surge peak forward current, single half sine-			50	А
wave superimposed on rated load per diode	t = 1.0ms	IFSM	120	А
Rating for fusing (t<8.3ms)		l ² t	10	A ² s
Junction temperature		TJ	-55 to +150	°C
Storage temperature		T _{STG}	-55 to +150	°C



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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-lead thermal resistance	R _{OJL}	15	°C/W		
Junction-to-ambient thermal resistance	Reja	48	°C/W		
Junction-to-case thermal resistance	Rejc	6	°C/W		

Thermal Performance Note: Units mounted on PCB (20mm x 20mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage per diode ⁽¹⁾	I _F = 1A, T _J = 25°C		1.06	-	V
	I _F = 2A, T _J = 25°C		1.16	1.30	V
	I _F = 1A, T _J = 125°C	V _F	0.89	-	V
	I _F = 2A, T _J = 125°C		1.00	1.16	V
Doverse current @ reted V per diade(2)	T _J = 25°C	_	-	5	μΑ
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 125°C	I _R	-	90	μΑ
Junction capacitance per diode	1MHz, V _R = 4.0V	CJ	15	-	pF
Maximum reverse recovery time	I _F = 0.5A , I _R = 1.0A I _{II} = 0.25A	t _{rr}	-	300	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
RABS20M	ABS	5,000 / Tape & Reel	



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

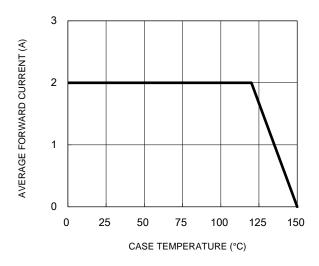


Fig.3 Typical Reverse Characteristics

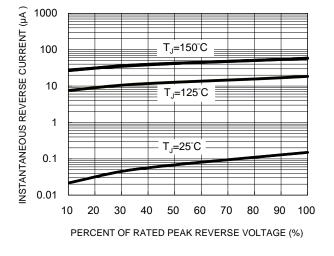


Fig.2 Typical Junction Capacitance

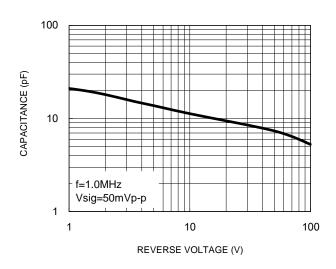
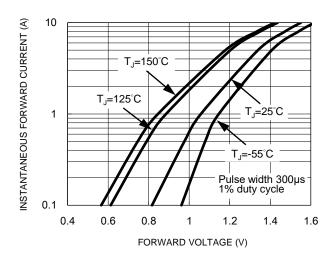


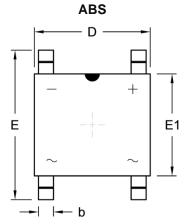
Fig.4 Typical Forward Characteristics

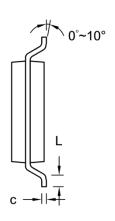




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PACKAGE OUTLINE DIMENSIONS

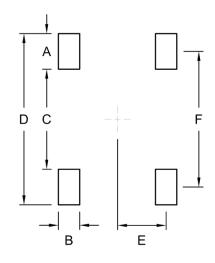




+ A I	 A2
A1 e ———————————————————————————————————	1

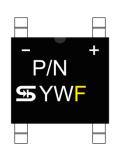
DIM.	Unit (mm)		Unit (inch)	
Dilvi.	Min.	Max.	Min.	Max.
А	1.40	1.60	0.055	0.063
A1	0.05	0.15	0.002	0.006
A2	1.35	1.45	0.053	0.057
b	0.60	0.70	0.024	0.028
С	0.15	0.25	0.006	0.010
D	4.90	5.10	0.193	0.201
E	6.25	6.65	0.246	0.262
E1	4.30	4.50	0.169	0.177
е	3.90	4.10	0.154	0.161
L	0.30	0.70	0.012	0.028

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	1.50	0.059
В	0.90	0.035
С	4.22	0.166
D	7.22	0.284
E	2.05	0.081
F	5.72	0.225

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code





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